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JC987

PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10002724	FILING DATE 10 25 2001	CLASS 438	SUBCLASS	GAU 2812	EXAMINER
<b>**APPLICANTS:</b> Madrid Ruben Palacpac Diosdado.					
<b>**CONTINUING DATA VERIFIED:</b> THIS APPLN CLAIMS BENEFIT OF 60:257.939 12/21:2000					
<b>**FOREIGN APPLICATIONS VERIFIED:</b>					
PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials				ATTORNEY DOCKET NO TI-27987	
TITLE : Method and system for manufacturing ball grid array ("BGA") packages					

PTO-2040  
12/99

<b>NOTICE OF ALLOWANCE MAILED</b>		<b>CLAIMS ALLOWED</b>	
		Assistant Examiner	
<b>ISSUE FEE</b>		Total Claims	
Amount Due	Date Paid	Print Claim for O.G.	
		<b>DRAWING</b>	
		Sheets Drwg. Figs.Drwg. Print Fig.	
		Primary Examiner	
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		Application Examiner	
		<b>PREPARED FOR ISSUE</b>	
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